

In the Claims:

Please cancel Claim 17 without prejudice.

Please amend Claims 1, 7, 8, 9, 13, 14 and 15 as follows:

B1 1. (TWICE AMENDED) An optoelectronic component group which is mounted on a support (3) and which comprises plural LEDs (2) at a prescribed distance (a) have a packing density of at least 4 LEDs per square centimeter, and associated connecting lines (4), wherein the support (3) has a thermal conductivity of at least 1.5 W/Kxm.

B2 7. (TWICE AMENDED) The optoelectronic component group according to Claim 1, wherein the plural LEDs (2) are arranged regularly on the support.

5 8. (TWICE AMENDED) The optoelectronic component group according to Claim 7, wherein the plural LEDs (2) form an array, with a prescribed distance (a and b) in the rows and columns, respectively.

7 9. (TWICE AMENDED) The optoelectronic component group according to Claim 6, wherein the distance between adjacent LEDs is less than 2 mm.

B3 13. (TWICE AMENDED) An optoelectronic component group which is mounted on an exterior mounting surface of a support (3) and which comprises plural LEDs (2), which are spaced apart from one another and have a packing density of at least 4 LEDs per square centimeter, and associated connecting lines (4), wherein the support (3) dissipates heat well enough to realize a distance between adjacent LEDs of less than 2 mm, without limiting the specified forward current of the LEDs and without further aids.

B4 14. (AMENDED) The optoelectronic component group of claim 1, wherein said support has an exterior mounting surface and said plural LEDs are mounted directly on said exterior mounting surface.

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